



CUSTOMER ADVISORY

ADV2006

Label Content Update for FPGA and Power Products

Description:

Intel® is notifying customers of a minor change to the content of custom barcode labels on the immediate, intermediate, and shipping containers (e.g. Moisture Barrier Bag (MBB), Inner Box, Reel, Shipping Box).

The words “RoHS Compliant” will no longer be printed on the labels.

This is only a label content change.

There is no change to the product materials.

This is not a notification of change to RoHS Compliance status of the product.

A separate notification (ADV2002) was issued for the same change on Intel standard labels of FPGA and Power Products.

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/pcn/adv2002.pdf>

Table 1:

Change From	Change To
“RoHS COMPLIANT” printed on the lower left of the barcode label	“RoHS COMPLIANT” not printed on the barcode label. *During transition period, customers may or may not see “RoHS compliant” printed on the label.

See Attachment sent together with this document for the sample labels.

Recommended Actions:

Customers are being notified to take note of this minor label content change, and as needed, to alert their relevant incoming inspection, receiving, and manufacturing personnel.

Upon implementation, Intel will ship products with either labels until inventory with the old label is depleted.

For products affected with the EU RoHS Exemption 15 expiry:

- Best efforts will be made to re-label affected inventory to sync with expiry date.
- After February 29, 2020, should there be a case where the label has a print "RoHS COMPLIANT" but the product contains leaded bump 1st level interconnect and is outside the scope of EU RoHS Exemption 15a, customers may contact the local Sales or Customer Service representative.

Note that this label change is applied across the board to all FPGA and Power products – both on devices affected and not affected by RoHS Exemption 15.

Products Affected:

All Intel FPGA and Power Products

The complete list of affected part numbers (OPNs) is the same for ADV2002 and can be downloaded in Excel form:

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/pcn/adv2002-opn-list.xlsx>

Reason for Change:

This change is related to the modified scope of EU RoHS (Restriction of Hazardous Substances) Directive Exemption 15.

Certain part numbers that are currently RoHS compliant under Exemption 15 will cease to be compliant starting in February 29, 2020.

The label content change is to prevent displaying an inaccurate status of RoHS compliance and prevent confusion during the transition period.

Note that this change is applied across the board to all FPGA and Power products – both on devices affected and not affected by RoHS Exemption 15.

Change Implementation:

Table 4

Milestone	Date
Earliest shipment of products with the label change (with or without “RoHS COMPLIANT” print)	February 24, 2020

Contact:

For more information, please contact your local Sales representative, or submit a question or request at the [My Intel](#) support page, log-in via:

<https://www.intel.com/content/www/us/en/my-intel/fpga-sign-in.html>

Customer Notifications Subscription:

Customers that subscribe to Intel FPGA customer notification mailing list will receive the notifications automatically via email.

If you would like to receive Intel FPGA customer notifications by email, you can register to the Intel FPGA program and set up your subscription at:

<https://www.intel.com/content/www/us/en/programmable/my-intel/mal-emailsub/technical-updates.html>.

Revision History:

Date	Rev	Description
02/24/2020	1.0.0	Initial Release

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